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### FAIRCHILD

SEMICONDUCTOR

November 2013

## **FQB6N80**

## **N-Channel QFET® MOSFET**

800 V, 5.8 A, 1.95 Ω

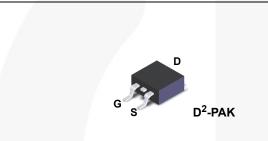
#### Description

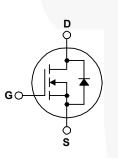
This N-Channel enhancement mode power MOSFET is • 5.8 A, 800 V,  $R_{DS(on)}$  = 1.95  $\Omega$  (Max.) @ V<sub>GS</sub> = 10 V, produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state D = 2.9 A Low Gate Charge (Typ. 31 nC) resistance, and to provide superior switching performance . Low Crss (Typ. 14 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

#### Features

- $I_{D} = 2.9 A$

- · RoHS Compiant





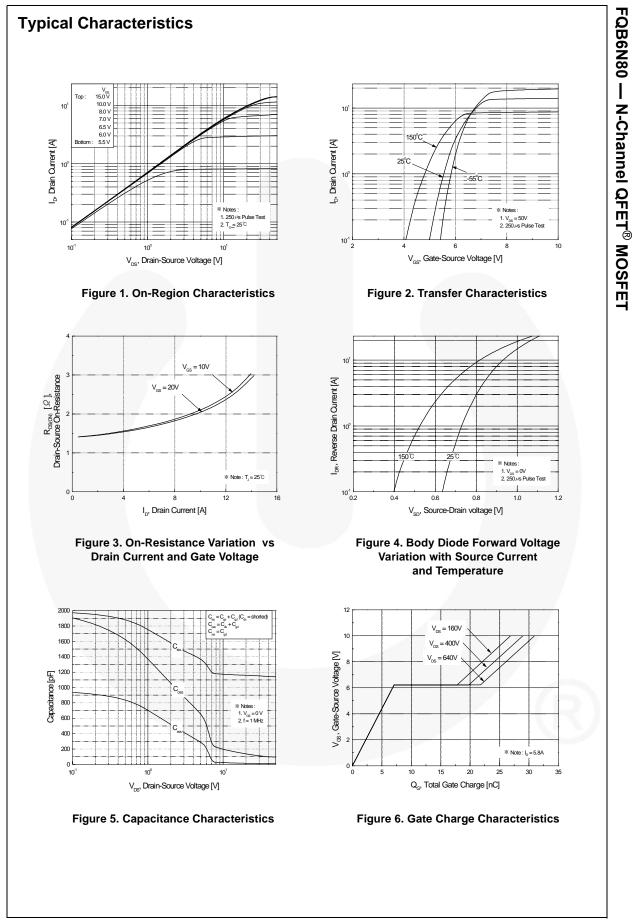
#### Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted.

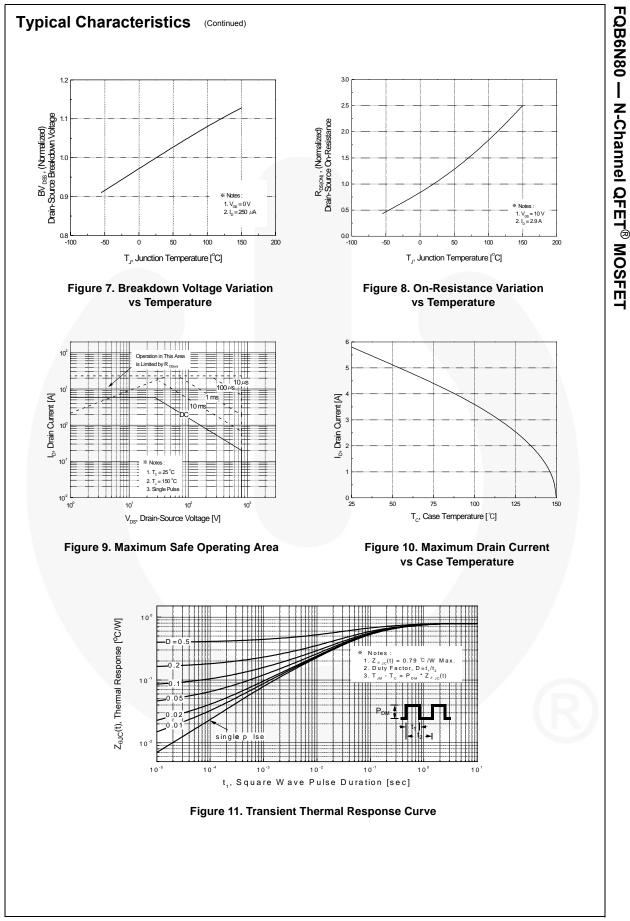
Symbol	Parameter		FQB6N80TM	Unit
V <sub>DSS</sub>	Drain-Source Voltage		800	V
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^{\circ}C$ )		5.8	A
	- Continuous (T <sub>C</sub> = 100°C)		3.67	A
I <sub>DM</sub>	Drain Current - Pulsed (N	ote 1)	23.2	A
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (N	ote 2)	680	mJ
I <sub>AR</sub>	Avalanche Current (N	ote 1)	5.8	A
E <sub>AR</sub>	Repetitive Avalanche Energy (N	ote 1)	15.8	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.0	V/ns
P <sub>D</sub>	Power Dissipation $(T_A = 25^{\circ}C)^*$		3.13	W
	Power Dissipation $(T_C = 25^{\circ}C)$		158	W
	- Derate above 25°C		1.27	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering,         1/8" from case for 5 seconds.		300	°C

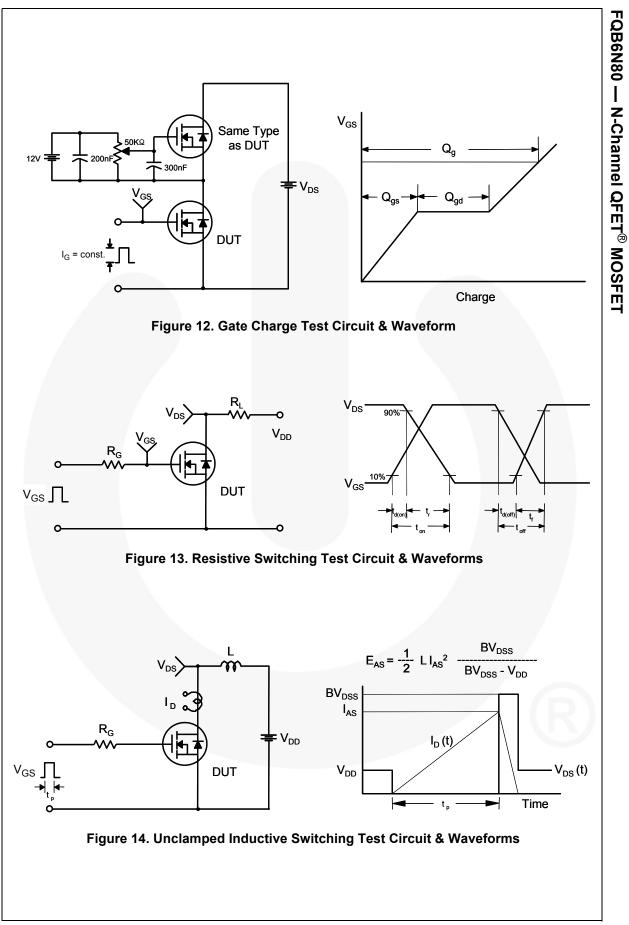
#### **Thermal Characteristics**

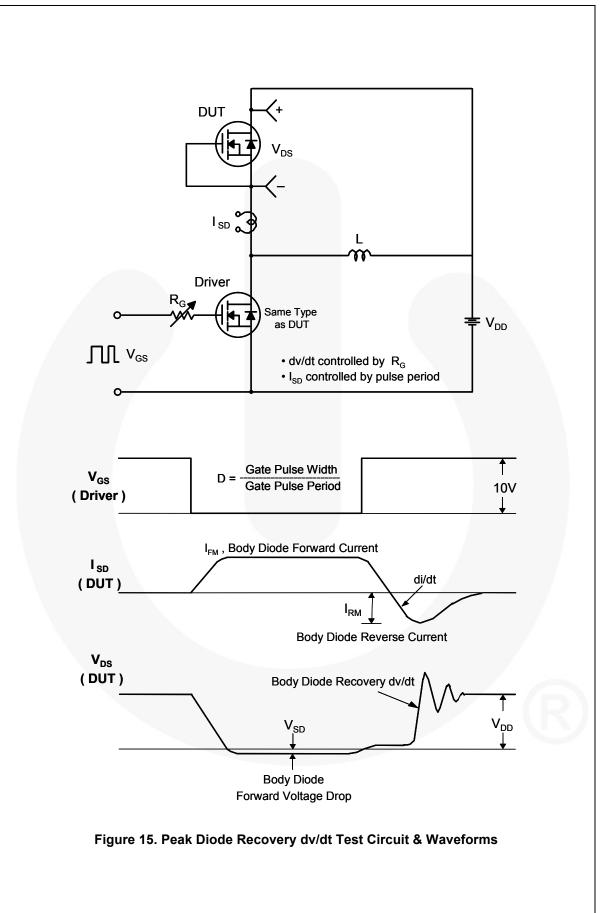
Symbol	Parameter FQB6N80TM		Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.79	
Р	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient (*1 in <sup>2</sup> Pad of 2-oz Copper), Max.	40	

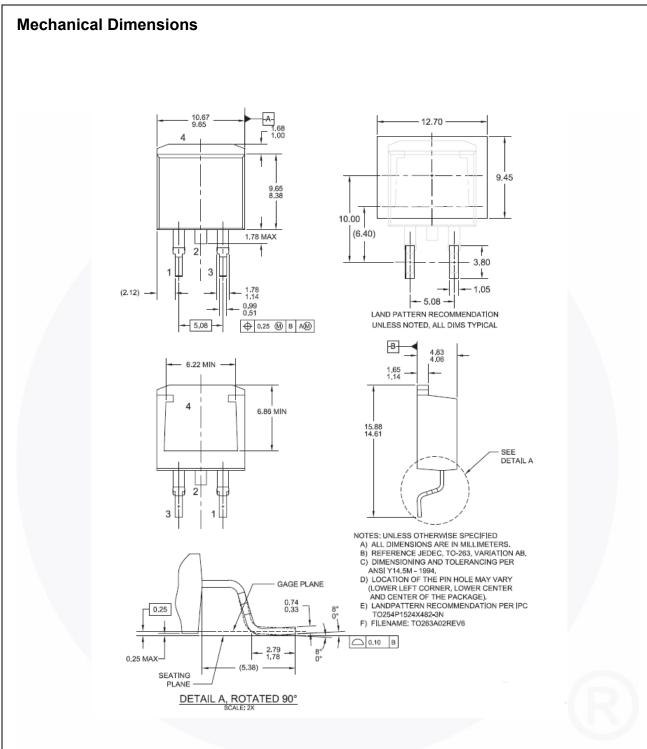
icsrce Breakdown Voltage $V_{GS} = 0 \text{ V}, I_D = 250 \mu \text{A}$ n Voltage Temperature $I_D = 250 \mu \text{A}, \text{Reference}$ Voltage Drain Current $V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$ VLeakage Current, Forward $V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$ V Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ V Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ V Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ ics $V_{DS} = V_{GS}, I_D = 250 \mu \text{A}$ shold Voltage $V_{DS} = V_{GS}, I_D = 250 \mu \text{A}$ n-Source $V_{DS} = 10 \text{ V}, I_D = 2.9 \text{ A}$ ransconductance $V_{DS} = 50 \text{ V}, I_D = 2.9 \text{ A}$ cteristics $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$ ransfer Capacitance $V_{DD} = 400 \text{ V}, I_D = 5.8 \text{ A}$ relay Time $V_{DD} = 400 \text{ V}, I_D = 5.8 \text{ A}$	Test Conditions $V_{GS} = 0 V, I_D = 250 \mu A$ $_D = 250 \mu A$ , Referenced to 25°C $V_{DS} = 800 V, V_{GS} = 0 V$ $V_{DS} = 640 V, T_C = 125°C$ $V_{GS} = 30 V, V_{DS} = 0 V$ $V_{GS} = -30 V, V_{DS} = 0 V$ $V_{DS} = V_{GS}, I_D = 250 \mu A$ $V_{DS} = 50 V, I_D = 2.9 A$ $V_{DS} = 25 V, V_{GS} = 0 V, I_D = 2.9 A$ $V_{DS} = 25 V, V_{GS} = 0 V, I_T = 1.0 MHz$ $V_{DD} = 400 V, I_D = 5.8 A, I_T = 1.0 MHz$	Conditions         M           = 250 $\mu$ A         80           teferenced to 25°C         -           /GS = 0 V         -           TC = 125°C         -           DS = 0 V         -           'DS = 0 V         -           '2.9 A         -           = 2.9 A         -	800        ed to 25°C      0.9       //         ?C              A     3.0         1.5        5.5	0.9 10 100 100 100 100	V V/°C μA ) μA ) nA 0 nA
icsrce Breakdown Voltage $V_{GS} = 0 \text{ V}, I_D = 250 \mu \text{A}$ n Voltage Temperature $I_D = 250 \mu \text{A}, \text{Reference}$ Voltage Drain Current $V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$ VLeakage Current, Forward $V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$ V Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ V Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ V Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ ics $V_{DS} = V_{GS}, I_D = 250 \mu \text{A}$ shold Voltage $V_{DS} = V_{GS}, I_D = 250 \mu \text{A}$ n-Source $V_{DS} = 10 \text{ V}, I_D = 2.9 \text{ A}$ ransconductance $V_{DS} = 50 \text{ V}, I_D = 2.9 \text{ A}$ cteristics $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1.0 \text{ MHz}$ ransfer Capacitance $V_{DD} = 400 \text{ V}, I_D = 5.8 \text{ A}$ relay Time $V_{DD} = 400 \text{ V}, I_D = 5.8 \text{ A}$	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$ $D_{D} = 250 \mu\text{A}, \text{ Referenced to } 25^{\circ}\text{C}$ $V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 640 \text{V}, T_{C} = 125^{\circ}\text{C}$ $V_{GS} = 30 \text{V}, V_{DS} = 0 \text{V}$ $V_{GS} = -30 \text{V}, V_{DS} = 0 \text{V}$ $V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$ $V_{DS} = 10 \text{V}, I_{D} = 2.9 \text{A}$ $V_{DS} = 50 \text{V}, I_{D} = 2.9 \text{A}$ $V_{DS} = 25 \text{V}, V_{GS} = 0 \text{V}, I_{D} = 2.9 \text{A}$ $V_{DS} = 25 \text{V}, V_{GS} = 0 \text{V}, I_{D} = 2.9 \text{A}$ $V_{DS} = 25 \text{V}, V_{GS} = 0 \text{V}, I_{D} = 2.9 \text{A}$ $V_{DS} = 400 \text{V}, I_{D} = 5.8 \text{A}, I_{D} = 1.0 \text{A}$	$= 250 \ \mu A \qquad 8i$ Referenced to 25°C $\frac{1}{C_{S}} = 0 \ V \qquad -1$ $T_{C} = 125°C \qquad -2$ $T_{DS} = 0 \ V \qquad -2$ $= 250 \ \mu A \qquad 3i$ $= 2.9 \ A \qquad -2i$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	 0.9 100 100 100 100 5.0 1.5 1.95 5.9	V V/°C μA ) μA ) nA 0 nA
rcc Breakdown Voltage $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ n Voltage Temperature $I_D = 250 \mu\text{A}, \text{Reference}$ Voltage Drain Current $V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$ VLeakage Current, Forward $V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$ V Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ V Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ ics $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ shold Voltage $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ n-Source $V_{DS} = 50 \text{ V}, I_D = 2.9 \text{ A}$ ance $V_{DS} = 50 \text{ V}, I_D = 2.9 \text{ A}$ cteristics $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 1.0 \text{ MHz}$ ransfer Capacitance $V_{DS} = 400 \text{ V}, I_D = 5.8 \text{ A}$ relay Time $V_{DD} = 400 \text{ V}, I_D = 5.8 \text{ A}$	$D_{D} = 250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$ $V_{DS} = 800 \ \text{V}, V_{GS} = 0 \ \text{V}$ $V_{DS} = 640 \ \text{V}, T_{C} = 125^{\circ}\text{C}$ $V_{GS} = 30 \ \text{V}, V_{DS} = 0 \ \text{V}$ $V_{GS} = -30 \ \text{V}, V_{DS} = 0 \ \text{V}$ $V_{DS} = V_{GS}, I_{D} = 250 \ \mu\text{A}$ $V_{GS} = 10 \ \text{V}, I_{D} = 2.9 \ \text{A}$ $V_{DS} = 50 \ \text{V}, I_{D} = 2.9 \ \text{A}$ $V_{DS} = 25 \ \text{V}, V_{GS} = 0 \ \text{V}, I_{D} = 1.0 \ \text{MHz}$	Leferenced to $25^{\circ}C$ $V_{GS} = 0 V$ $T_{C} = 125^{\circ}C$ $D_{S} = 0 V$ $D_{S} = 0 V$ $= 250 \mu A$ $= 2.9 A$ $G_{S} = 0 V$ $D_{S} = 0 V$ </th <th>ed to 25°C      0.5       /         ?C              A     3.0        A     3.0         1.5        5.5        115        125</th> <th>0.9  100  100  100  5.0 1.5 1.98 5.9</th> <th>V/°C μA ) μA ) nA 0 nA</th>	ed to 25°C      0.5       /         ?C              A     3.0        A     3.0         1.5        5.5        115        125	0.9 100 100 100 5.0 1.5 1.98 5.9	V/°C μA ) μA ) nA 0 nA
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Notage Temperature t $I_D = 250 \ \mu$ A, ReferenceVoltage Drain Current $V_{DS} = 800 \ V, V_{GS} = 0 \ V$ $V_{DS} = 640 \ V, T_C = 125^{\circ}$ $V_{DS} = 0 \ V$ $V_{CS} = 30 \ V, V_{DS} = 0 \ V$ ics shold Voltage n-Source ance ransconductance $V_{DS} = -30 \ V, V_{DS} = 0 \ V$ $V_{DS} = 10 \ V, I_D = 2.9 \ A$ $V_{DS} = 50 \ V, I_D = 2.9 \ A$ eteristics acitance ransfer Capacitancevolume relay Time tion Time $V_{DD} = 400 \ V, I_D = 5.8 \ A$	$D_{D} = 250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$ $V_{DS} = 800 \ \text{V}, V_{GS} = 0 \ \text{V}$ $V_{DS} = 640 \ \text{V}, T_{C} = 125^{\circ}\text{C}$ $V_{GS} = 30 \ \text{V}, V_{DS} = 0 \ \text{V}$ $V_{GS} = -30 \ \text{V}, V_{DS} = 0 \ \text{V}$ $V_{DS} = V_{GS}, I_{D} = 250 \ \mu\text{A}$ $V_{GS} = 10 \ \text{V}, I_{D} = 2.9 \ \text{A}$ $V_{DS} = 50 \ \text{V}, I_{D} = 2.9 \ \text{A}$ $V_{DS} = 25 \ \text{V}, V_{GS} = 0 \ \text{V}, I_{D} = 1.0 \ \text{MHz}$	Leferenced to $25^{\circ}C$ $V_{GS} = 0 V$ $T_{C} = 125^{\circ}C$ $D_{S} = 0 V$ $D_{S} = 0 V$ $= 250 \mu A$ $= 2.9 A$ $G_{S} = 0 V$ $D_{S} = 0 V$ </td <td>ed to 25°C      0.5       /         ?C              A     3.0        A     3.0         1.5        5.5        115        125</td> <td> 10  100  100 100  5.0 1.5 1.95 5.9</td> <td>V/°C μA ) μA ) nA 0 nA</td>	ed to 25°C      0.5       /         ?C              A     3.0        A     3.0         1.5        5.5        115        125	10 100 100 100 5.0 1.5 1.95 5.9	V/°C μA ) μA ) nA 0 nA
Voltage Drain Current $V_{DS} = 800 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 640 \text{ V}, \text{ T}_{C} = 125^{\circ}$ $V_{DS} = 640 \text{ V}, \text{ T}_{C} = 125^{\circ}$ $V_{DS} = 640 \text{ V}, \text{ T}_{C} = 125^{\circ}$ $V_{GS} = 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$ $V_{Leakage Current, Reverse}$ $V_{GS} = 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$ $V_{GS} = -30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$ ics shold Voltageshold Voltage $V_{DS} = V_{GS}, \text{ I}_{D} = 250 \mu\text{A}$ $V_{CS} = 10 \text{ V}, \text{ I}_{D} = 2.9 \text{ A}$ ransconductanceransconductance $V_{DS} = 50 \text{ V}, \text{ I}_{D} = 2.9 \text{ A}$ cteristics $V_{DS} = 50 \text{ V}, \text{ I}_{D} = 2.9 \text{ A}$ ransfer Capacitance $V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1.0 \text{ MHz}$ relay Time $V_{DD} = 400 \text{ V}, \text{ I}_{D} = 5.8 \text{ A}$	$V_{DS} = 640 \text{ V},  \text{T}_{C} = 125^{\circ}\text{C}$ $V_{GS} = 30 \text{ V},        $	$ \frac{1}{C} = 125^{\circ}C \qquad . $ $ \frac{1}{DS} = 0  V \qquad . $ $ = 250 \mu A \qquad . $ $ = 2.9  A \qquad . $ $ \frac{1}{GS} = 0  V, \qquad . $ $ \frac{1}{D} = 5.8  A, \qquad . $	<sup>2</sup> C   A 3.0 1.5 5.9 115 129	100 100 100 5.0 1.5 1.95 5.9	0 μA 0 nA 0 nA
Voltage Drain Current $V_{DS} = 640 \text{ V}, \text{ T}_{C} = 125^{\circ}$ V Leakage Current, Forward $V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$ v Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ v Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ ics $V_{DS} = V_{GS}, I_D = 250 \mu \text{A}$ shold Voltage $V_{DS} = V_{GS}, I_D = 250 \mu \text{A}$ n-Source $V_{DS} = 10 \text{ V}, I_D = 2.9 \text{ A}$ ransconductance $V_{DS} = 50 \text{ V}, I_D = 2.9 \text{ A}$ cteristicsacitanceacitance $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 2.9 \text{ A}$ cteristicsacitanceacitance $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 1.0 \text{ MHz}$ ransfer Capacitance $V_{DD} = 400 \text{ V}, I_D = 5.8 \text{ A}$ tice Time $V_{DD} = 400 \text{ V}, I_D = 5.8 \text{ A}$	$V_{DS} = 640 \text{ V},  \text{T}_{C} = 125^{\circ}\text{C}$ $V_{GS} = 30 \text{ V},        $	$ \frac{1}{C} = 125^{\circ}C \qquad . $ $ \frac{1}{DS} = 0  V \qquad . $ $ = 250 \mu A \qquad . $ $ = 2.9  A \qquad . $ $ \frac{1}{GS} = 0  V, \qquad . $ $ \frac{1}{D} = 5.8  A, \qquad . $	<sup>2</sup> C   A 3.0 1.5 5.9 115 129	100 100 100 5.0 1.5 1.95 5.9	0 μA 0 nA 0 nA
V Leakage Current, Forward $V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$ V Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ V Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ ics $V_{DS} = V_{GS}, I_D = 250 \mu \text{A}$ shold Voltage $V_{DS} = V_{GS}, I_D = 250 \mu \text{A}$ n-Source $V_{DS} = 10 \text{ V}, I_D = 2.9 \text{ A}$ ransconductance $V_{DS} = 50 \text{ V}, I_D = 2.9 \text{ A}$ cteristics $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 2.9 \text{ A}$ cteristics $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 1.0 \text{ MHz}$ ransfer Capacitance $V_{DD} = 400 \text{ V}, I_D = 5.8 \text{ A}$ relay Time $V_{DD} = 400 \text{ V}, I_D = 5.8 \text{ A}$	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{DS} = V_{GS}, I_D = 250 \text{ \muA}$ $V_{GS} = 10 \text{ V}, I_D = 2.9 \text{ A}$ $V_{DS} = 50 \text{ V}, I_D = 2.9 \text{ A}$ $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ $F = 1.0 \text{ MHz}$ $V_{DD} = 400 \text{ V}, I_D = 5.8 \text{ A},$	$\frac{1}{DS} = 0 V$ $= 250 \mu A$ $= 2.9 A$	A 3.0 1.5 5.6 115 129	100 100 5.0 1.5 1.98 5.9	0 nA 0 nA
v Leakage Current, Reverse $V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ icsvshold Voltage $V_{DS} = V_{GS}, I_D = 250 \mu \text{A}$ n-Source $V_{GS} = 10 \text{ V}, I_D = 2.9 \text{ A}$ ransconductance $V_{DS} = 50 \text{ V}, I_D = 2.9 \text{ A}$ ransconductance $V_{DS} = 50 \text{ V}, I_D = 2.9 \text{ A}$ ransconductance $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, I_D = 2.9 \text{ A}$ rateristicsransfer Capacitanceransfer Capacitance $f = 1.0 \text{ MHz}$ relay Time $V_{DD} = 400 \text{ V}, I_D = 5.8 \text{ A}$	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{DS} = V_{GS}, I_D = 250 \text{ µA}$ $V_{GS} = 10 \text{ V}, I_D = 2.9 \text{ A}$ $V_{DS} = 50 \text{ V}, I_D = 2.9 \text{ A}$ $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ i = 1.0  MHz $V_{DD} = 400 \text{ V}, I_D = 5.8 \text{ A},$	$= 250 \ \mu A \qquad 3$ $= 2.9 \ A \qquad -$ $= -$ $= -$	A 3.0 1.5 5.5 115 129	5.0 1.5 1.98 5.9	0 nA
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velay Time VDD = 400 V, ID = 5.8 A		<sub>D</sub> = 5.8 A,	12		
elay Time $V_{DD} = 400 \text{ V}, \text{ I}_{D} = 5.8 \text{ A}$		<sub>D</sub> = 5.8 A,		14 18	pF
$v_{DD} = 400 \text{ V}, \text{ I}_D = 5.8 \text{ A}$		<sub>D</sub> = 5.8 A,			
			30	30 70	ns
$R_{\rm G} = 25 \Omega$	4, <b>- - -</b>			70 150	) ns
elay Time	-			65 140	) ns
all Time	(Note 4	(Note 4)	(Note 4) 45	45 100	) ns
				31	nC
Charge V <sub>DS</sub> = 640 V, I <sub>D</sub> = 5.8 A	V <sub>DS</sub> = 640 V, I <sub>D</sub> = 5.8 A,				nC
Charge $V_{DS} = 640 \text{ V}, \text{ I}_D = 5.8 \text{ A}$ tee Charge $V_{GS} = 10 \text{ V}$		<sub>D</sub> = 5.8 A,	., 31	7.1	nC
	V <sub>GS</sub> = 10 V	<sub>D</sub> = 5.8 A,	A, 31 7.1	7.1        15	
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ce Charge       V <sub>S</sub> = 10 V         n Charge       V <sub>GS</sub> = 10 V         ode Characteristics and Maximum Rating         Continuous Drain-Source Diode Forward Current         Pulsed Drain-Source Diode Forward Current	$V_{GS} = 10 V$ (Note 4 <b>I Maximum Ratings</b> e Forward Current ward Current $V_{GS} = 0 V, I_S = 5.8 A$	D = 5.8 A, (Note 4)	N, 31 7.1 (Note 4) 15 gs  	15 5.8 23.2	2 A
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#### Figure 16. TO263 (D<sup>2</sup>PAK), Molded, 2-Lead, Surface Mount

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